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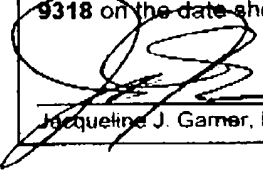
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## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Jiang et al. Art Unit: 1765  
Serial No.: 09/966,605 Examiner: Vinh, L.  
Filing Date: 09/28/2001 Docket No.: TI-31462  
Title: IN-SITU PLASMA ASH/TREATMENT AFTER VIA ETCH OF  
LOW-K FILMS FOR POISON-FREE DUAL DAMASCENE  
TRENCH PATTERNING

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NAME OF INVENTOR(S): Jiang		RECEIPT DATE & SERIAL NO.: Serial No.: 09/966,605	
TITLE OF INVENTION: In-Situ Plasma Ash/Treatment		Filing Date: 09/28/2001	
TI FILE NO.: TI-31462	DEPOSIT ACCT. NO.: 20-0668		
FAXED: 9/9/2003 DUE: 7/9/2003 ATTY/SECY: JJG			

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